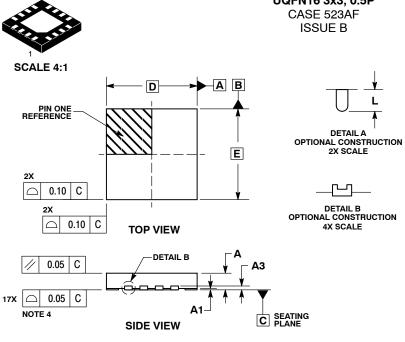
DETAIL A

e/2 е



F2

16X h

0.10

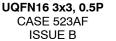
0.05

CAB

C NOTE 3

13

BOTTOM VIEW



DATE 04 NOV 2015

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- DIMENSIONING AND TOLERANGING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.30 MM FROM TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
АЗ	0.127 REF		
b	0.20	0.30	
D	3.00 BSC		
D2	1.60	1.80	
Е	3.00 BSC		
E2	1.60	1.80	
е	0.50 BSC		
K	0.20		
Ĺ	0.30	0.50	

GENERIC MARKING DIAGRAM*



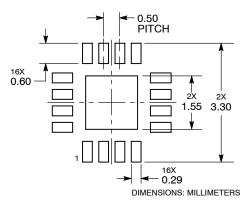
XXXX = Specific Device Code

Α = Assembly Location

= Wafer Lot L = Year W = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	UQFN16, 3X3, 0.5P		PAGE 1 OF 1

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